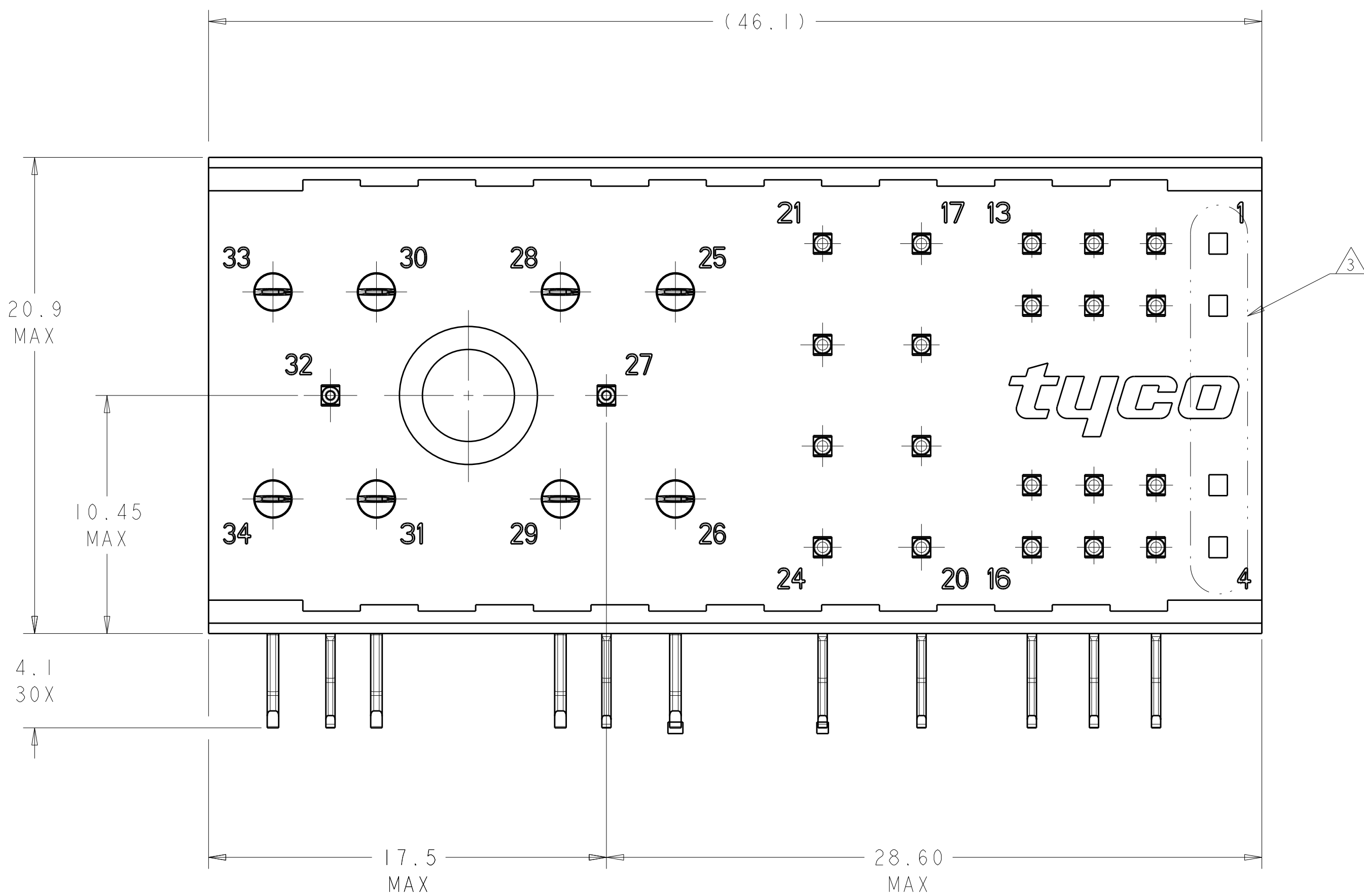




HOUSING: HIGH TEMP THERMOPLASTIC, UL94V-0, GRAY.
SIGNAL CONTACTS: COPPER ALLOY
POWER CONTACTS: COPPER ALLOY

ALL OVER: 0.00127 MIN NICKEL
COMPLIANT PIN AREA: 0.00127 MIN TIN
MATING AREA: 0.00076 MIN GOLD

 HOLES INDICATED ARE NOT REQUIRED FOR TYCO PRODUCT.

 DATUM AND BASIC DIMENSION TO BE ESTABLISHED BY CUSTOMER.

ALL OVER:	0.00127	MIN	NICKEL
COMPLIANT PIN AREA:	0.00127	MIN	TIN-LEAD
MATING AREA:	0.00076	MIN	GOLD

9. THIS DRAWING IS RESTRICTED TO HUAWEI CORPORATION

	Ø 0.762	22	22	2085066-2
	Ø 1.58	8	16	
	Ø 0.762	22	22	2085066-1
	Ø 1.58	8	16	
PLATING	MATING PIN DIAMETER	CONTACT QTY	SIZE NO	PART NO

Pro/ENGINEER DRAWING